PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Chie Shishido	02/02/2009
Maki Tanaka	01/30/2009
Atsushi Miyamoto	02/02/2009

RECEIVING PARTY DATA

Name:	Hitachi, Ltd.	
Street Address:	6-6, Marunouchi 1-chome	
Internal Address:	Chiyoda-ku	
City:	Tokyo	
State/Country:	JAPAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12370870

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	501.49654X00
NAME OF SUBMITTER:	Melvin Kraus

Total Attachments: 1

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PATENT

REEL: 022609 FRAME: 0660

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ASSIGNMENT

(譲 渡 証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi, Ltd., a corporation organized under the laws of Japan,

located at 6-6, Marunouchi 1-chome, Chiyoda-ku, Tokyo, Japan

receipt of which is hereby acknowledged I do hereby sell and assign to said. Hitachi, Ltd.,

its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

SCANNING ELECTRON MICROSCOPE SYSTEM AND METHOD FOR MEASURING DIMENSIONS OF PATTERNS FORMED ON SEMICONDUCTOR DEVICE BY USING THE SYSTEM

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said Hitachi, Ltd.,

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi, Ltd.,

Signed on the date(s) indicated aside our signatures:

RECORDED: 04/29/2009

INIVENTOR(C)

	INVENTOR(S) (発明者フルネームサ	Date Signed (署名日)	
1)	Chie Shishido	Chie SHISHIDO	Feb. 2.2009
2)	Marki Tanaha	Maki TANAKA	Jan. 30, 2009
3)	Utsushi Miyamots	Atsushi MIYAMOTO	Feb. 2, 2009
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PATENT REEL: 022609 FRAME: 0661